

OUR TOP TAKEAWAYS FROM OCP GLOBAL SUMMIT 2025

1

Two-phase direct-to-chip's TCO benefits resonated with data center operators.

Recent analysis from Jacobs Engineering shows our NeuCool® solution can deliver 5-year TCO savings of up to 17%, largely thanks to its streamlined design and superior thermal performance. With a greater price-performance ratio vs. single-phase, it's no wonder why industry leaders would show a strong interest in our products.

2

CDU firmware has garnered greater industry attention—alongside higher standards.

There's a growing interest for firmware that enables CDUs to communicate with other critical infrastructure throughout a data center. Fortunately, our in-house firmware team keeps our NeuView™ software platform up to date as industry standards evolve.

3

Concerns over single-phase direct-to-chip served as key topics in many crowded sessions.

Attendees expressed worries over PG25's observed risks of cold plate erosion, higher flow rates, and continual need for maintenance across multiple sessions. With 2P D2C, however, you could've spent your time elsewhere—our dielectric refrigerant is a “set-it-and-forget-it” solution that has zero risk of erosion and delivers higher performance at lower pressures.

4

We're recognized as the leader in two-phase direct-to-chip liquid cooling.

Throughout our conversations with booth visitors and thought leaders at the OCP Global Summit, one message rang clear: we've cemented our reputation as the leader in two-phase direct-to-chip. Be sure to contact us if you need advanced liquid cooling that's designed for the mission critical.